DGG OR DL PACKAGE

16-BIT 2.5-V TO 3.3-V/3.3-V TO 5-V LEVEL-SHIFTING TRANSCEIVER WITH 3-STATE OUTPUTS

SCAS416L - MARCH 1994 - REVISED FEBRUARY 2004

- Member of the Texas Instruments
 Widebus™ Family
- Max t_{pd} of 5.8 ns at 3.3 V
- ±24-mA Output Drive at 3.3 V
- Latch-Up Performance Exceeds 250 mA Per JESD 17

description/ordering information

This 16-bit (dual-octal) noninverting bus transceiver contains two separate supply rails. B port has V_{CCB} , which is set to operate at 3.3 V and 5 V. A port has V_{CCA} , which is set to operate at 2.5 V and 3.3 V. This allows for translation from a 2.5-V to a 3.3-V environment, and vice versa, or from a 3.3-V to a 5-V environment, and vice versa.

The SN74ALVC164245 is designed for asynchronous communication between data buses.

To ensure the high-impedance state during power up or power down, the output-enable (\overline{OE}) input should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

	(TOP VI	EW)	
1DIR	₁ U	48	10E
1B1			
1B2] <mark>1</mark> A1] 1A2
GND [200	GND
1B3 [1 1A3
1B4 [1 1A4
(3.3 V, 5 V) V _{CCB}		42	V _{CCA} (2.5 V, 3.3 V)
1B5		41	1 1A5
=			1A6
GND [I GND
1B7 [1A7
1B8 [37	1A8
2B1 [
2B2	14	35	2A1 2A2
GND		34	GND
2B3 [16	33	2A3
2B4 [17	32	2A4
(3.3 V, 5 V) V _{CCB} [18	31	V _{CCA} (2.5 V, 3.3 V)
2B5 [30] 2A5
2B6 [20	29] 2A6
GND [21	28] GND
2B7 [22	27] 2A7
2B8 [23	26	2A8
2DIR [24	25] 2 <mark>0E</mark>
			- C C - W

ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
11/2	0000 01 000	Tube of 25	SN74ALVC164245DL	411/0404045
No. of London	SSOP - DL	Reel of 1000	SN74ALVC164245DLR	ALVC164245
4000 1- 0500	TOOOD DOO	Reel of 2000	SN74ALVC164245DGGR	111/0404045
-40°C to 85°C	TSSOP – DGG	Reel of 250	SN74ALVC164245DGGT	ALVC164245
	VFBGA – GQL	Reel of 1000	SN74ALVC164245KR	V04045
	VFBGA – ZQL (Pb-free)		74ALVC164245ZQLR	VC4245

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE (each 8-bit section)

INP	UTS				
ŌE	DIR	OPERATION			
L	L	B data to A bus			
L	Н	A data to B bus			
Н	Χ	Isolation			

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



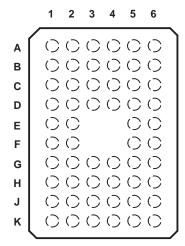


SN74ALVC164245

16-BIT 2.5-V TO 3.3-V/3.3-V TO 5-V LEVEL-SHIFTING TRANSCEIVER

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GQL OR ZQL PACKAGE (TOP VIEW)

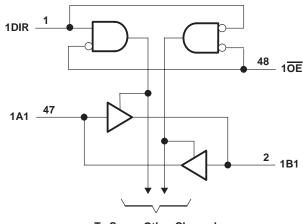


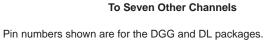
terminal assignments

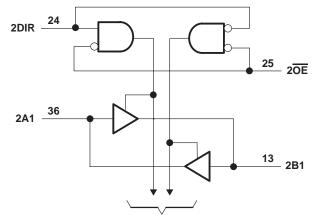
	1	2	3	4	5	6
Α	1DIR	NC	NC	NC	NC	10E
В	1B2	1B1	GND	GND	1A1	1A2
С	1B4	1B3	V _{CCB}	VCCA	1A3	1A4
D	1B6	1B5	GND	GND	1A5	1A6
Е	1B8	1B7			1A7	1A8
F	2B1	2B2			2A2	2A1
G	2B3	2B4	GND	GND	2A4	2A3
Н	2B5	2B6	VCCB	VCCA	2A6	2A5
J	2B7	2B8	GND	GND	2A8	2A7
K	2DIR	NC	NC	NC	NC	2OE

NC - No internal connection

logic diagram (positive logic)







To Seven Other Channels

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absolute maximum ratings over operating free-air temperature range for V_{CCB} at 5 V and V_{CCA} at 3.3 V (unless otherwise noted) $\!\!\!\!\!^{\dagger}$

Supply voltage range: V _{CCA}		
V _{CCB}		–0.5 V to 6 V
Input voltage range, V _I : Except I/O ports (see N	Note 1)	
I/O port A (see Note 2)		–0.5 V to V _{CCA} + 0.5 V
I/O port B (see Note 1)		–0.5 V to V _{CCB} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)		–50 mA
Output clamp current, I _{OK} (V _O < 0)		–50 mA
Continuous output current, IO		±50 mA
Continuous current through each V _{CC} or GND		±100 mA
Package thermal impedance, θ_{JA} (see Note 3):	DGG package	70°C/W
-	DL package	63°C/W
	GQL/ZQL package	42°C/W
Storage temperature range, T _{sta}		

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. This value is limited to 6 V maximum.
 - 2. This value is limited to 4.6 V maximum.
 - 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions for V_{CCB} at 3.3 V and 5 V (see Note 4)

			MIN	MAX	UNIT
VCCB	Supply voltage		3	5.5	V
V _{IH}	High-level input voltage		2		V
.,	Law law Canada salta na	V _{CCB} = 3 V to 3.6 V		0.7	
VIL	Low-level input voltage	V _{CCB} = 4.5 V to 5.5 V		0.8	V
V _{IA}	Input voltage		0	VCCB	V
VOB	Output voltage		0	VCCB	V
ІОН	High-level output current			-24	mA
lOL	Low-level output current			24	mA
Δt/Δν	Input transition rise or fall rate			10	ns/V
TA	Operating free-air temperature			85	°C

NOTE 4: All unused inputs of the device must be held at the associated V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



SN74ALVC164245 16-BIT 2.5-V TO 3.3-V/3.3-V TO 5-V LEVEL-SHIFTING TRANSCEIVER WITH 3-STATE OUTPUTS SCAS416L - MARCH 1994 - REVISED FEBRUARY 2004

recommended operating conditions for V_{CCA} at 2.5 V and 3.3 V (see Note 4)

			MIN	MAX	UNIT
VCCA	Supply voltage		2.3	3.6	V
Maria	High level inner college	V _{CCA} = 2.3 V to 2.7 V	1.7		V
VIH	High-level input voltage	V _{CCA} = 3 V to 3.6 V	2		V
Mari	Law laval input valtage	V _{CCA} = 2.3 V to 2.7 V		0.7	V
VIL	Low-level input voltage	V _{CCA} = 3 V to 3.6 V		0.8	V
V _{IB}	Input voltage		0	V_{CCA}	V
VOA	Output voltage		0	VCCA	V
1	High level compart	V _{CCA} = 2.3 V		-18	A
Іон	High-level output current	V _{CCA} = 3 V		-24	mA
	Lave lavel autout aumant	V _{CCA} = 2.3 V		18	^
lOL	Low-level output current	V _{CCA} = 3 V		24	mA
Δt/Δν	Input transition rise or fall rate			10	ns/V
TA	Operating free-air temperature		-40	85	°C

NOTE 4: All unused inputs of the device must be held at the associated V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range for V_{CCA} = 2.7 V to 3.6 V and V_{CCB} = 4.5 V to 5.5 V (unless otherwise noted)

PAI	RAMETER	TEST CONDITIONS	VCCA	V _{CCB}	MIN	TYP [†]	MAX	UNIT	
		$I_{OH} = -100 \mu A$	2.7 V to 3.6 V		V _{CC} -0.2)			
		404	2.7 V		2.2			.,	
		I _{OH} = -12 mA	3 V		2.4			V	
		I _{OH} = -24 mA	3 V		2				
		100.4		4.5 V	4.3				
., ,	. 5)	I _{OH} = -100 μA		5.5 V	5.3			.,	
V _{OH} (A	то в)			4.5 V	3.7			V	
		I _{OH} = -24 mA		5.5 V	4.7				
		I _{OL} = 100 μA	2.7 V to 3.6 V				0.2		
V _{OL} (B	to A)	I _{OL} = 12 mA	2.7 V				0.4 V		
		I _{OL} = 24 mA	3 V				0.55		
	. 5)	I _{OL} = 100 μA		4.5 V to 5.5 V			0.2	.,	
V _{OL} (A	to B)	I _{OL} = 24 mA		4.5 V to 5.5 V			0.55	V	
Ц	Control inputs	V _I = V _{CCA} /V _{CCB} or GND	3.6 V	5.5 V			±5	μΑ	
l _{OZ} ‡	A or B ports	$V_O = V_{CCA}/V_{CCB}$ or GND	3.6 V	5.5 V			±10	μΑ	
Icc		$V_I = V_{CCA}/V_{CCB}$ or GND, $I_O = 0$	5.5 V	5.5 V			40	μΑ	
ΔlCC§		One input at V _{CCA} /V _{CCB} – 0.6 V, Other inputs at V _{CCA} /V _{CCB} or GND	3 V to 3.6 V	4.5 V to 5.5 V			750	μΑ	
Ci	Control inputs	V _I = V _{CCA} /V _{CCB} or GND	3.3 V	5 V		6.5		pF	
C _{io}	A or B ports	VO = VCCA/VCCB or GND	3.3 V	3.3 V		8.5		pF	

[†] Typical values are measured at $V_{CCA} = 3.3 \text{ V}$ and $V_{CCB} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



[‡] For I/O ports, the parameter IOZ includes the input leakage current.

[§] This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than at 0 or the associated VCC.

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electrical characteristics over recommended operating free-air temperature range for V_{CCA} = 2.3 V to 2.7 V and V_{CCB} = 3 V to 3.6 V (unless otherwise noted)

PA	RAMETER	TEST CONDITIONS	VCCA	VCCB	MIN	MAX	UNIT	
		$I_{OH} = -100 \mu A$	2.3 V to 2.7 V	3 V to 3.6 V	V _{CCA} -0.2			
VOH (B	3 to A)	$I_{OH} = -8 \text{ mA}$	2.3 V	3 V to 3.6 V	1.7		V	
		I _{OH} = -12 mA	2.7 V	3 V to 3.6 V	1.8			
\/ /A	(- D)	I _{OH} = -100 μA	2.3 V to 2.7 V	3 V to 3.6 V	V _{CCB} -0.2		.,	
V _{OH} (A	(to B)	I _{OH} = -18 mA	2.3 V to 2.7 V	3 V	2.2		V	
V _{OL} (B to A)		I _{OL} = 100 μA	2.3 V to 2.7 V	3 V to 3.6 V		0.2		
		I _{OL} = 12 mA	2.3 V	3 V to 3.6 V		0.6	V	
\/ /A	(- D)	I _{OL} = 100 μA	2.3 V to 2.7 V	3 V to 3.6 V		0.2	.,	
V _{OL} (A	то в)	I _{OL} = 18 mA	2.3 V	3 V		0.55	V	
II	Control inputs	V _I = V _{CCA} /V _{CCB} or GND	2.3 V to 2.7 V	3 V to 3.6 V		±5	μΑ	
loz†	A or B ports	$V_O = V_{CCA}/V_{CCB}$ or GND	2.3 V to 2.7 V	3 V to 3.6 V		±10	μΑ	
ICC		$V_I = V_{CCA}/V_{CCB}$ or GND, $I_O = 0$	2.3 V to 2.7 V	3 V to 3.6 V		20	μΑ	
∆l _{CC} ‡		One input at V _{CCA} /V _{CCB} – 0.6 V, Other inputs at V _{CCA} /V _{CCB} or GND	2.3 V to 2.7 V	3 V to 3.6 V		750	μА	

[†] For I/O ports, the parameter IOZ includes the input leakage current.

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figures 1-4)

		то	V _{CCB} = 3.3 V ± 0.3 V	V _{CCB} = 5	$V \pm 0.5 V$	
PARAMETER	PARAMETER FROM (INPUT)		V _{CCA} = 2.5 V ± 0.2 V	V _{CCA} = 2.7 V	V _{CCA} = 3.3 V ± 0.3 V	UNIT
			MIN MAX	MIN MAX	MIN MAX	
	А	В	7.6	5.9	1 5.8	
^t pd	В	А	7.6	6.7	1.2 5.8	ns
t _{en}	ŌĒ	В	11.5	9.3	1 8.9	ns
^t dis	ŌĒ	В	10.5	9.2	2.1 9.5	ns
t _{en}	ŌĒ	А	12.3	10.2	2 9.1	ns
^t dis	ŌĒ	А	9.3	9	2.9 8.6	ns

operating characteristics, T_A = 25°C

				V _{CCB} = 3.3 V	V _{CCB} = 5 V		
	PARAMETER	TEST CONDITIONS	V _{CCA} = 2.5 V	V _{CCA} = 3.3 V	UNIT		
				TYP	TYP		
		Outputs enabled (B)	C 50 pE	55	56		
	Power dissipation	Outputs disabled (B) $C_L = 50 \text{ pF}, f = 10 \text{ MHz}$		27	6	pF	
C _{pd}	capacitance	Outputs enabled (A)	C _I = 50 pF, f = 10 MHz	118	56	рг	
		Outputs disabled (A)	C[= 30 pr,	58	6		



[‡] This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than at 0 or the associated VCC.

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power-up considerations[†]

TI level-translation devices offer an opportunity for successful mixed-voltage signal design. A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies caused by improperly biased device pins. Take these precautions to guard against such power-up problems:

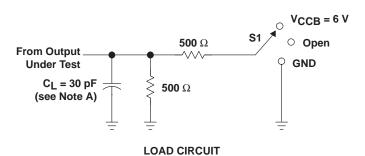
- 1. Connect ground before any supply voltage is applied.
- 2. Power up the control side of the device (V_{CCA} for all four of these devices).
- 3. Tie \overline{OE} to V_{CCA} with a pullup resistor so that it ramps with V_{CCA} .
- 4. Depending on the direction of the data path, DIR can be high or low. If DIR high is needed (A data to B bus), ramp it with V_{CCA}. Otherwise, keep DIR low.

† Refer to the TI application report, *Texas Instruments Voltage-Level-Translation Devices*, literature number SCEA021.

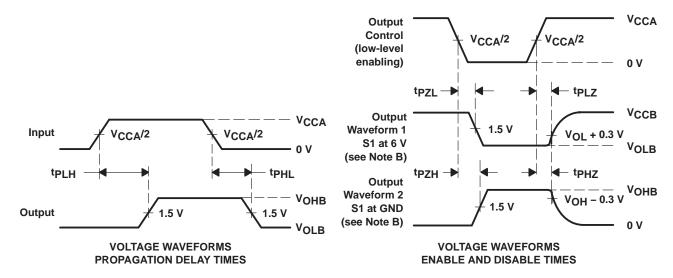


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PARAMETER MEASUREMENT INFORMATION V_{CCA} = 2.5 V \pm 0.2 V TO V_{CCB} = 3.3 V \pm 0.3 V



TEST	S1
t _{pd}	Open
tPLZ/tPZL	V _{CCB} = 6 V
tPHZ/tPZH	GND



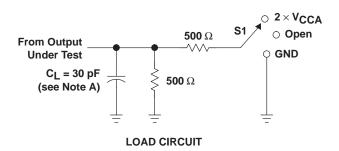
NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_0 = 50 Ω , $t_f\leq$ 2 ns. $t_f\leq$ 2 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

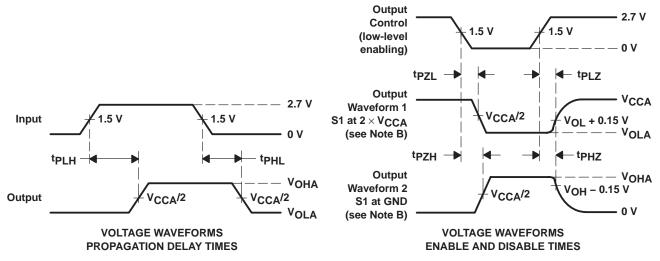
Figure 1. Load Circuit and Voltage Waveforms

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PARAMETER MEASUREMENT INFORMATION $V_{CCB} = 3.3 \text{ V} \pm 0.3 \text{ V}$ TO $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$



TEST	S 1
^t pd	Open
^t PLZ/tPZL	2×V _{CCA}
^t PHZ/tPZH	GND

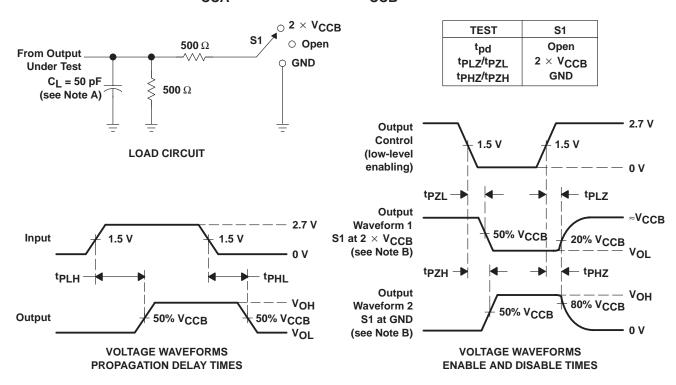


- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , $t_f\leq$ 2 ns. $t_f\leq$ 2 ns.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. tpLz and tpHz are the same as tdis.
 - F. tpzL and tpzH are the same as ten.
 - G. tpLH and tpHL are the same as tpd.

Figure 2. Load Circuit and Voltage Waveforms

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PARAMETER MEASUREMENT INFORMATION $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ TO $V_{CCB} = 5 \text{ V} \pm 0.5 \text{ V}$



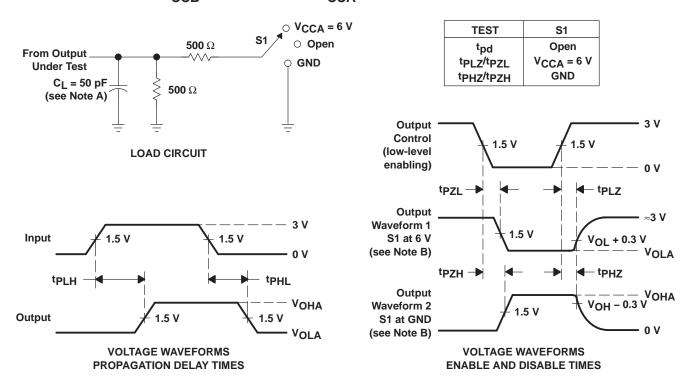
NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \,\Omega$, $t_f \leq 2.5 \,$ ns, $t_f \leq 2.5 \,$ ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 3. Load Circuit and Voltage Waveforms

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PARAMETER MEASUREMENT INFORMATION V_{CCB} = 5 V \pm 0.5 V TO V_{CCA} = 2.7 V AND 3.3 V \pm 0.3 V

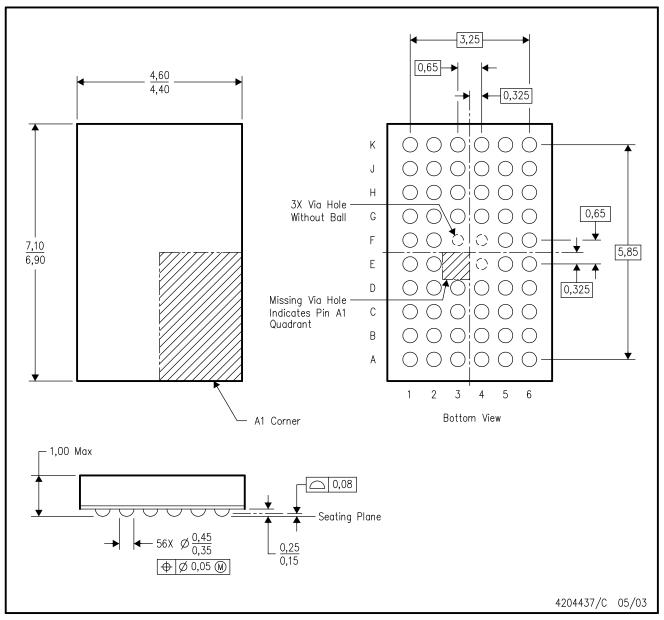


- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. tpl 7 and tpH7 are the same as tdis.
 - F. tpzL and tpzH are the same as ten.
 - G. tpLH and tpHL are the same as tpd.

Figure 4. Load Circuit and Voltage Waveforms

ZQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES:

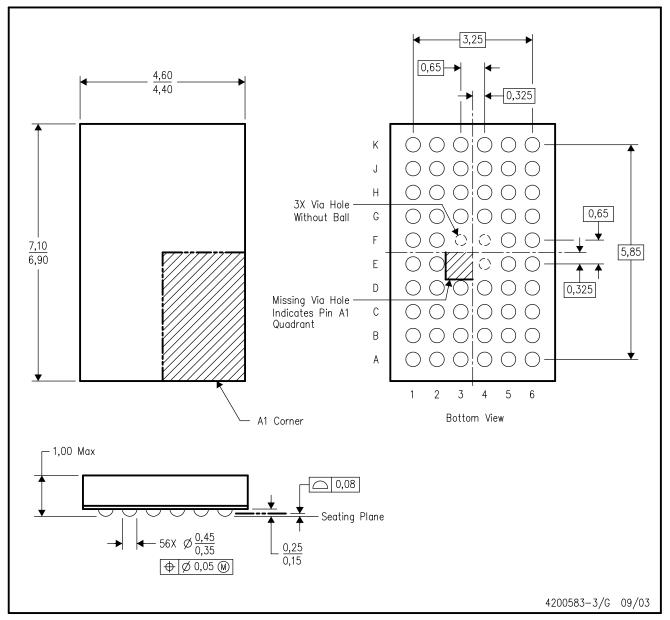
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. MicroStar Junior™ BGA configuration.
- D. Falls within JEDEC MO-225 variation BA.
- E. This package is lead—free. Refer to the 56 GQL package (drawing 4200583) for tin—lead (SnPb).

MicroStar Junior is a trademark of Texas Instruments.



GQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. MicroStar Junior™ BGA configuration.
- D. Falls within JEDEC MO-225 variation BA.
- E. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.

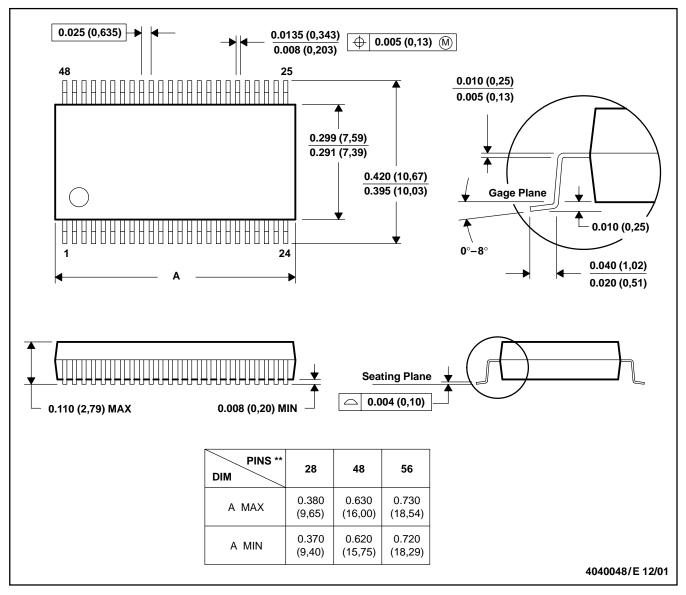
MicroStar Junior is a trademark of Texas Instruments.



DL (R-PDSO-G**)

48 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



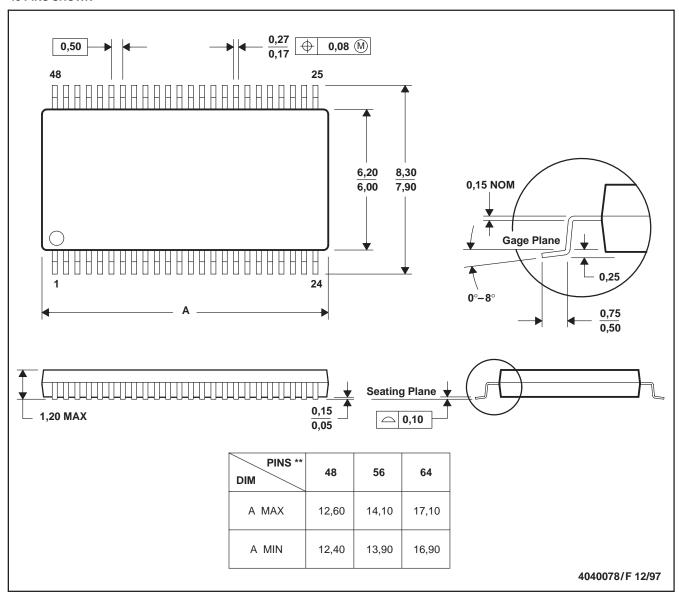
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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